

TMBF401 THRU TMBF410

SURFACE MOUNT BRIDGE RECTIFIERS

FEATURES:

Glass Passivated Chip Junction

• Reverse Voltage - 100 to 1000 V

• Forward Current - 4.0 A

• High Surge Current Capability

• Designed for Surface Mount Application

MECHANICAL DATA

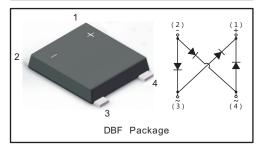
• Case: DBF (UMSB)

• Terminals: Solderable per MIL-STD-750, Method 2026

Approx. Weight: 0.234g / 0.00825oz

PINNING

| PIN | DESCRIPTION | | | |
|-----|----------------------|--|--|--|
| 1 | Output Anode (+) | | | |
| 2 | Output Cathode (-) | | | |
| 3 | Input Pin (~) | | | |
| 4 | 4 Input Pin (~) | | | |



Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

| Parameter | Symbols | TMBF401 | TMBF402 | TMBF404 | TMBF406 | TMBF 408 | TMBF410 | Units |
|---|--|--------------------|---------|---------|---------|----------|---------|-------|
| Maximum Repetitive Peak Reverse Voltage | V_{RRM} | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V _{RMS} | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | V _{DC} | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Average Rectified Output Current | Io | 4.0 | | | | | | А |
| Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method) | I _{FSM} | 150 | | | | | | А |
| Maximum Forward Voltage at 4.0 A | V _F | 1.1 | | | | | | V |
| Maximum DC Reverse Current @T _A =25 °C at Rated DC Blocking Voltage @T _A =125 °C | I _R | 5 100 | | | | | | μA |
| Typical Junction Capacitance (Note1) | C _j | 50 | | | | | pF | |
| Typical Thermal Resistance (Note2) | $R_{	ext{	iny BJA}}$ $R_{	ext{	iny BJC}}$ $R_{	ext{	iny BJL}}$ | 60 10 25 | | | | | °C/W | |
| Operating and Storage Temperature Range | T_{j},T_{stg} | -55 ~ + 150 | | | | | °C | |

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with $4 \times 1.5" \times 1.5"$ (3.81×3.81 cm) copper pad.



TMBF401 THRU TMBF410

SURFACE MOUNT BRIDGE RECTIFIERS

Characteristic Curves (T_A=25 °C unless otherwise noted)

Fig.1 Average Rectified Output Current **Derating Curve** 5.0 Average Rectified Output Current (A) 4.0 3.0 2.0 1.0 Resistive or Inductive Load 0.0 50 75 100 125 175 150 Case Temperature (°C)

Fig.2 Typical Reverse Characteristics

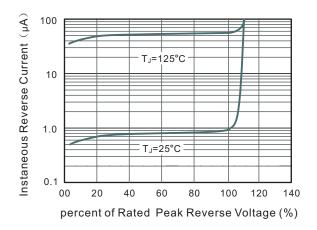


Fig.3 Typical Instaneous Forward Characteristics

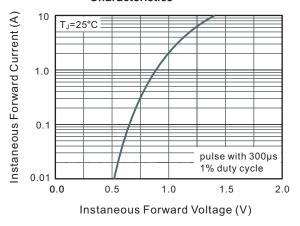


Fig.4 Typical Junction Capacitance

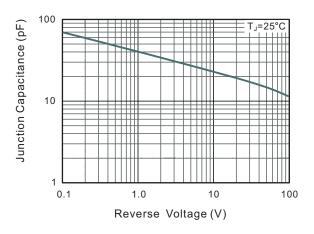


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

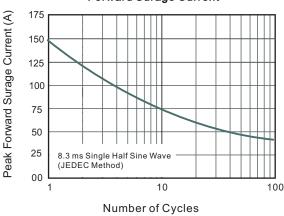
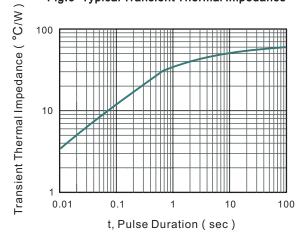


Fig.6- Typical Transient Thermal Impedance



version: 02

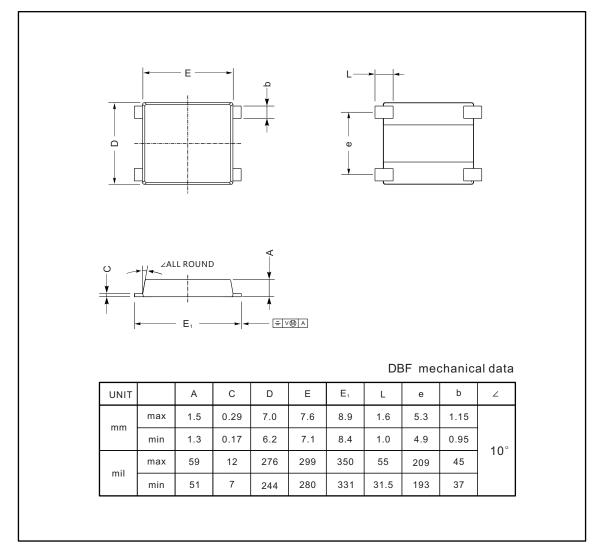


SURFACE MOUNT BRIDGE RECTIFIERS

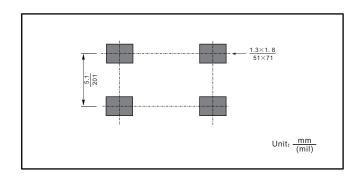
PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

DBF



The recommended mounting pad size



Marking

| Type number | Marking code | | | | |
|-------------|--------------|--|--|--|--|
| TMBF401 | TMBF401 | | | | |
| TMBF402 | TMBF402 | | | | |
| TMBF404 | TMBF404 | | | | |
| TMBF406 | TMBF406 | | | | |
| TMBF408 | TMBF408 | | | | |
| TMBF410 | TMBF410 | | | | |